

# HAT1059C

Silicon P Channel Power MOS FET  
Power Switching

# HITACHI

ADE-208-1450A (Z)

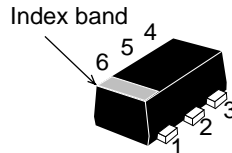
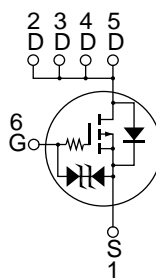
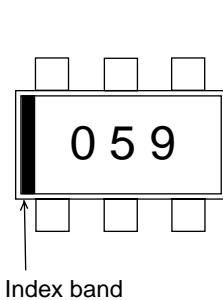
Rev.1  
Sep. 2001

## Features

- Low on-resistance  
 $R_{DS(on)} = 52 \text{ m}\Omega$  typ (at  $V_{GS} = -4.5 \text{ V}$ ,  $I_D = -1.5 \text{ A}$ )  
 $R_{DS(on)} = 71 \text{ m}\Omega$  typ (at  $V_{GS} = -2.5 \text{ V}$ ,  $I_D = -1.5 \text{ A}$ )  
 $R_{DS(on)} = 98 \text{ m}\Omega$  typ (at  $V_{GS} = -1.8 \text{ V}$ ,  $I_D = -1.5 \text{ A}$ )
- Capable of 1.8 V gate drive
- Small Package: CMFPAK-6

## Outline

CMFPAK - 6



1. Source
2. Drain
3. Drain
4. Drain
5. Drain
6. Gate

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	−12	V
Gate to source voltage	$V_{GSS}$	±8	V
Drain current	$I_D$	−3	A
Channel dissipation	Pch	0.65	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

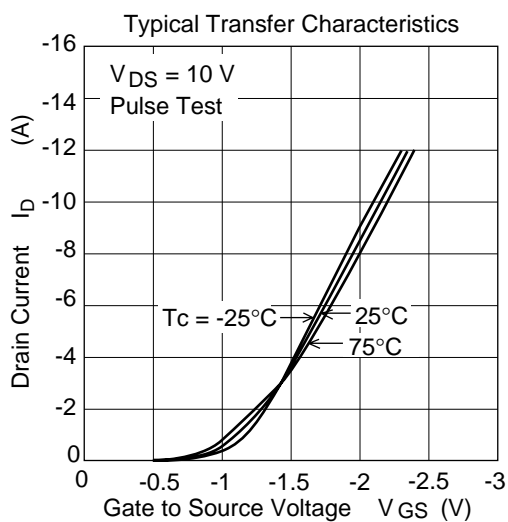
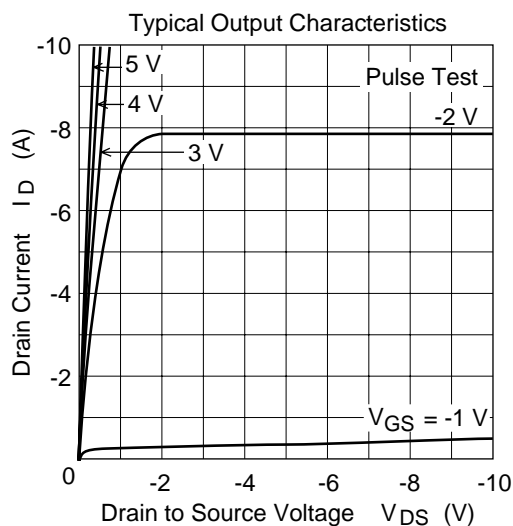
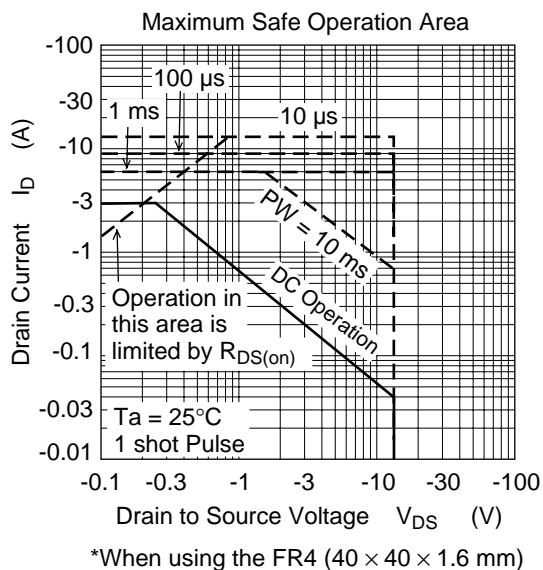
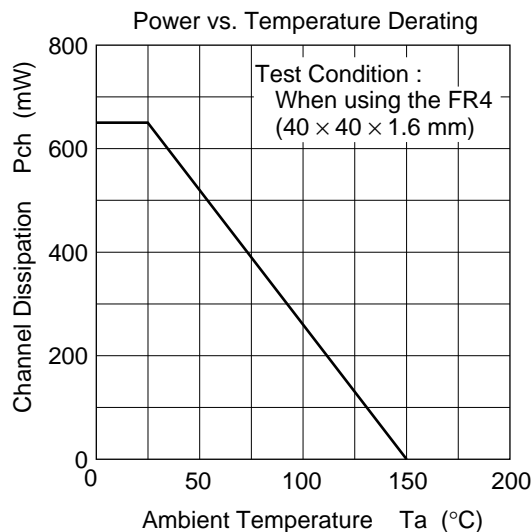
\*Value on the FR4. (40 × 40 × 1.6 mm)

Electrical Characteristics

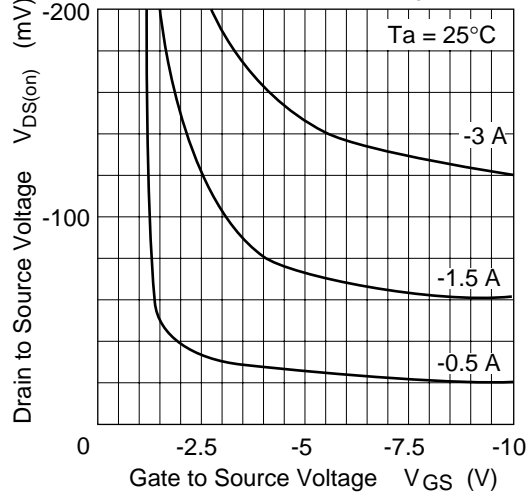
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	−12	—	—	V	$I_D = -10\text{ mA}$ , $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±8	—	—	V	$I_G = \pm 100\text{ }\mu\text{A}$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	± 10	μA	$V_{GS} = \pm 6.4\text{ V}$ , $V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	−1	μA	$V_{DS} = -12\text{ V}$ , $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	−0.2	—	−1.0	V	$I_D = -1\text{ mA}$ , $V_{DS} = -10\text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	52	64	mΩ	$I_D = -1.5\text{ A}$ , $V_{GS} = -4.5\text{ V}$
	$R_{DS(on)}$	—	71	88	mΩ	$I_D = -1.5\text{ A}$ , $V_{GS} = -2.5\text{ V}$
	$R_{DS(on)}$	—	98	126	mΩ	$I_D = -1.5\text{ A}$ , $V_{GS} = -1.8\text{ V}$
Forward transfer admittance	$ y_{fs} $	4	5	—	S	$I_D = -1.5\text{ A}$ , $V_{DS} = -10\text{ V}$
Input capacitance	Ciss	—	1080	—	pF	$V_{DS} = -10\text{ V}$
Output capacitance	Coss	—	215	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	150	—	pF	f = 1 MHz
Total gate charge	Qg	—	13	—	nC	$V_{DS} = -10\text{ V}$
Gate to source charge	Qgs	—	2.2	—	nC	$V_{GS} = -4.5\text{ V}$
Gate to drain charge	Qdg	—	3.8	—	nC	$I_D = -3\text{ A}$
Turn-on delay time	$t_{d(on)}$	—	35	—	ns	$V_{GS} = -4\text{ V}$ , $I_D = -1.5\text{ A}$
Rise time	$t_r$	—	170	—	ns	$R_L = 6.66\text{ }\Omega$
Turn-off delay time	$t_{d(off)}$	—	690	—	ns	
Fall time	$t_f$	—	460	—	ns	
Body–drain diode forward voltage	$V_{SDF}$	—	−0.85	−1.20	V	$I_F = -3.0\text{ A}$ , $V_{GS} = 0$

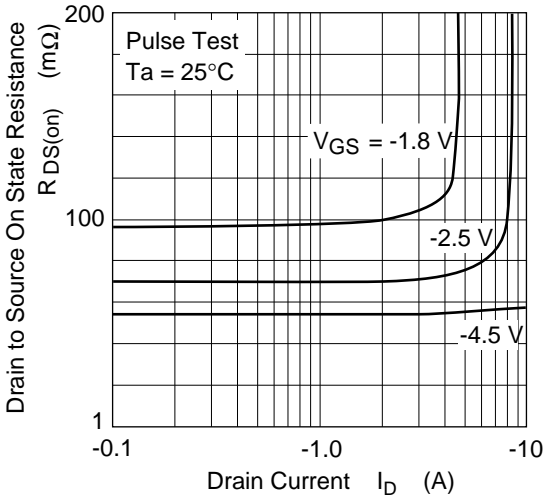
## Main Characteristics



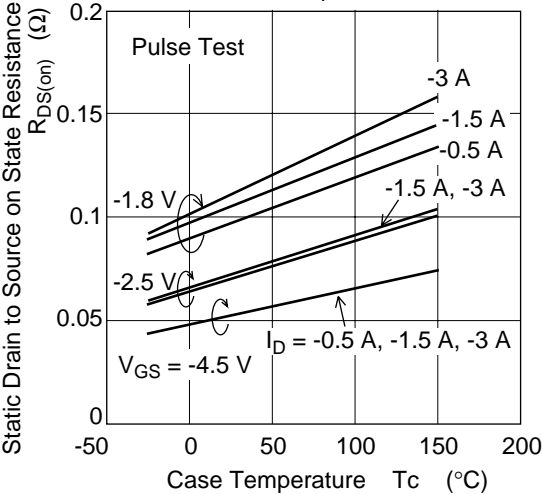
Drain to Source Saturation Voltage vs. Gate to Source Voltage



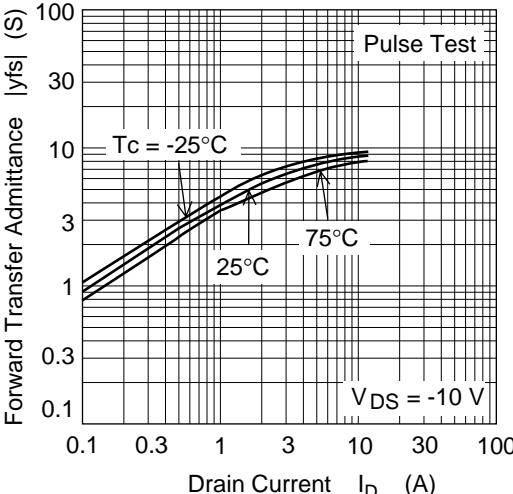
Static Drain to Source on State Resistance vs. Drain Current



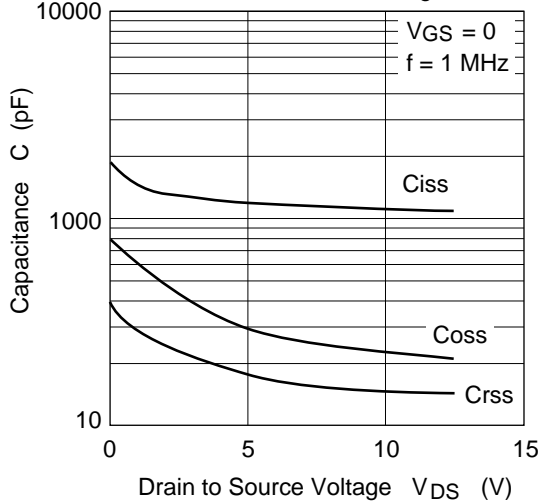
Static Drain to Source on State Resistance vs. Temperature



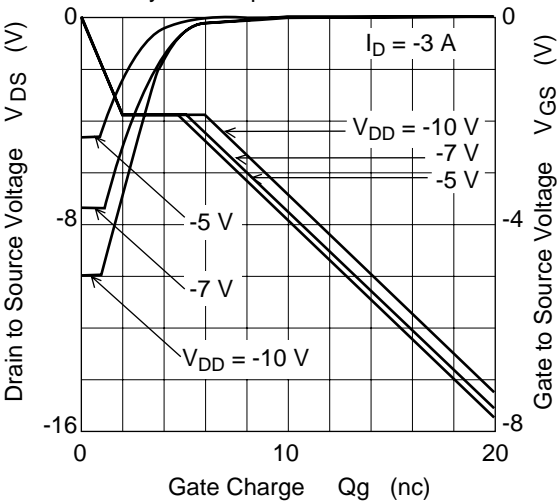
Forward Transfer Admittance vs. Drain Current



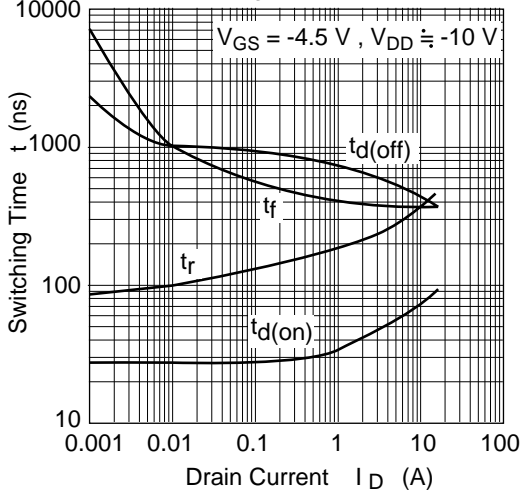
Typical Capacitance vs.  
Drain to Source Voltage



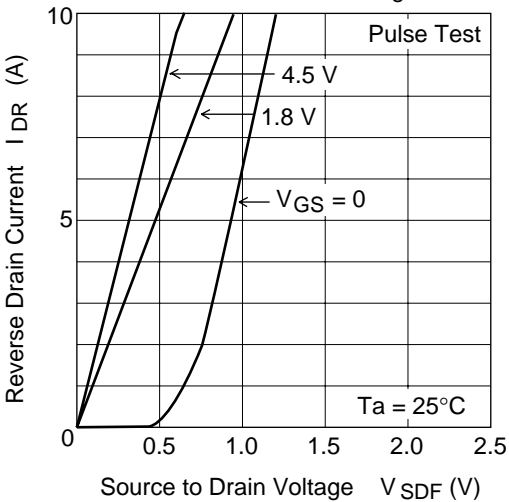
Dynamic Input Characteristics



Switching Characteristics

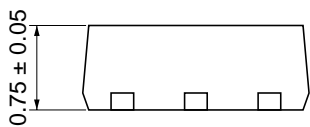
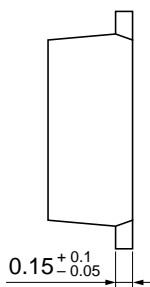
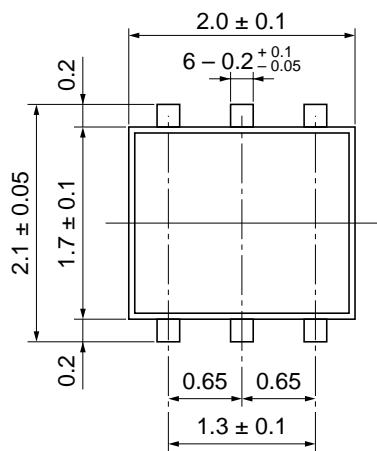


Reverse Drain Current vs.  
Source to Drain Voltage



Package Dimensions

Unit: mm



Hitachi Code	CMFPAK-6
JEDEC	—
JEITA	Conforms
Mass (reference value)	1.2 mg

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